## Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMENT			
CONVEYING PARTY DATA					
			ame	Execution Date	
SUN JAE HWANG 06/18/2008					
RECEIVING PARTY DATA					
Name:	DONGBU HITEK CO., LTD.				
Street Address:	891-10 DAECHI-DONG, GANGNAM-GU				
City:	SEOUL				
State/Country:	REPUBLIC OF KOREA				
Postal Code:	135-280				
PROPERTY NUMBERS Total: 1 Property Type Number					
		12143	3071		
CORRESPONDENCE DATA					
Fax Number:(352)372-5800Correspondence will be set via US Mail when the fax attempt is unsuccessful.Phone:3523758100Email:JL@SLSPATENTS.COMCorrespondent Name:JEFF LLOYDAddress Line 1:P.O. BOX 142950Address Line 4:GAINESVILLE, FLORIDA 32614-2950					00 07%
ATTORNEY DOCKET NUMBER:			SUN-DH-459		
NAME OF SUBMITTER:			JEFF LLOYD		
Total Attachments: 2 source=Executed-Asgn#page1.tif source=Executed-Asgn#page2.tif					

## ASSIGNMENT

WHEREAS, I, the undersigned, residing at the indicated address given below, respectively, have invented certain new and useful improvements in IMAGE SENSOR AND METHOD FOR MANUFACTURING THE SAME, for which an application for United States Letters Patent was filed <u>June 23, 2008</u>, as Serial No. <u>12/143,971</u>.

WHEREAS, DONGBU HITTEK CO., LTD., a corporation of the country of the Republic of Korea, having a place of business at 891-10 Daechi-dong, Gangnam-gu, Seoul 135-280, Republic of Korea is desirous of acquiring the entire right, title, and interest in and to said invention and in and to any Letters Patent which may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in view of valuable consideration, receipt of which is hereby acknowledged, I, the undersigned, have sold, assigned, and transferred, and by these presents do sell, assign, and transfer, unto said **DONGBU HITEK CO., LTD.**, its successors and assigns, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title, and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in any and all divisions, reissues, continuations, and extensions thereof.

I hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to **DONGBU HITEK CO.**, **LTD.**, as the assignee of the entire right, title, and interest in and to the same, for the sole use and behoof of said **DONGBU HITEK CO.**, **LTD.**, its successors and assigns.

FURTHER, I agree that I will communicate to said **DONGBU HITEK CO., LTD.**, or its representatives, any facts known to me respecting said invention; testify in any legal proceedings; sign all lawful papers; execute all divisional, continuation, substitution, renewal, and reissue applications; execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said **DONGBU HITEK CO., LTD.**; make all rightful oaths; and generally do everything possible to aid the said **DONGBU HITEK CO., LTD.**; its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

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PATENT REEL: 021135 FRAME: 0192

## Docket No. SUN-DH-459

18th IN TESTIMONY WHEREOF, I have hereunto set my hand this day of \_\_\_\_, 2008. Signature: HWANG, Sun Jae 101ho, Samsung Villa, 731-123ho Chang5-dong, Dobong-gu, Seoul, Republic of Korea Jan WITNESS: Signature: Koom tyung Printed Name:  $(\mathcal{A})$ 200 A June Date:

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## PATENT REEL: 021135 FRAME: 0193

**RECORDED: 06/23/2008**